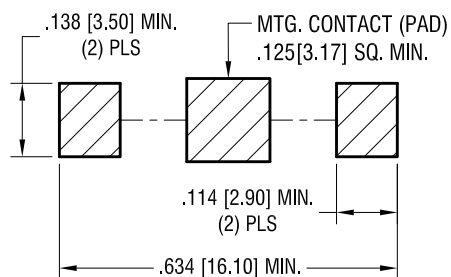
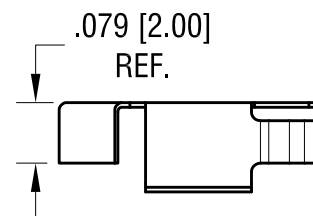
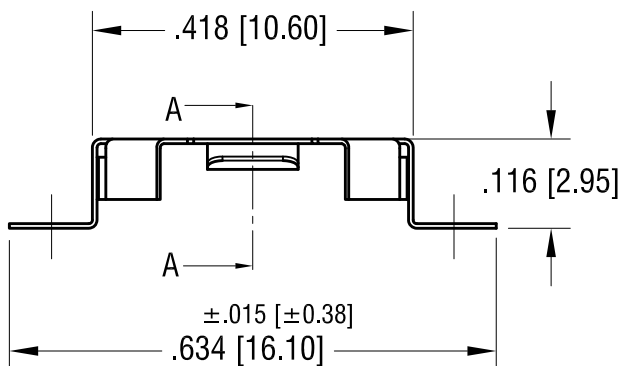
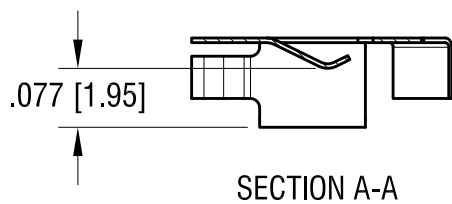
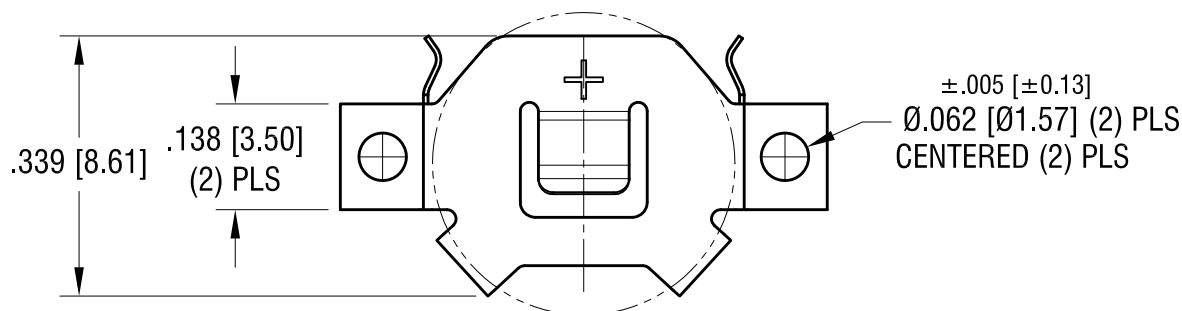


MOUNTING PAD LAYOUT



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ACTUAL SIZE



2.29.24	NO CHANGES TO PART	B
5.07.15	CHANGE AS PER ECN 15-054	A
DATE	DESCRIPTION	REV.

KEYSTONE ELECTRONICS CORP.			
www.keyelco.com • NEW HYDE PARK NY 11040 • Tel (516)328-7500			
PART NAME			
10mm SM COIN CELL CLIP			
MATERIAL			
.006 [0.15] TH'K PHOSPHOR BRONZE			
FINISH		DRN BY	DATE
TIN NICKEL PLATE		NT	9.17.10
		APP'D	SCALE
		RH	4X
TOLERANCES	INCH [MM]	CODE	DWG NO.
DECIMAL	±.010 [±0.25]	C	3030
ANGULAR	± 1°		
UNLESS OTHERWISE SPECIFIED			